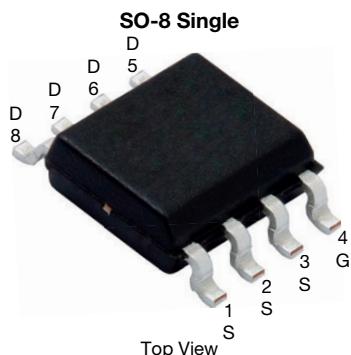


N-Channel 100 V (D-S) MOSFET

PRODUCT SUMMARY			
V_{DS} (V)	R_{DS(on)} (Ω) MAX.	I_D (A) ^a	Q_g (TYP.)
100	0.026 at V _{GS} = 10 V	10.3	5.8 nC
	0.033 at V _{GS} = 4.5 V	9.2	


Ordering Information:

Si4058DY-T1-GE3 (lead (Pb)-free and halogen-free)

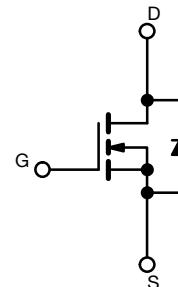
FEATURES

- ThunderFET® power MOSFET
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


RoHS
COMPLIANT
HALOGEN
FREE

APPLICATIONS

- DC/DC primary side switch
- Synchronous rectification
- Fast charger
- Industrial



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	V _{DS}	100	
Gate-Source Voltage	V _{GS}	± 20	V
Continuous Drain Current (T _J = 150 °C)	I _D	10.3	A
		8.3	
		7 b, c	
		5.5 b, c	
Pulsed Drain Current (t = 300 µs)	I _{DM}	50	
Continuous Source-Drain Diode Current	I _S	5	
Single Pulse Avalanche Current	I _{AS}	15	
Avalanche Energy	E _{AS}	11.2	mJ
Maximum Power Dissipation	P _D	5.6	W
		3.6	
		2.6 b, c	
		1.6 b, c	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +150	°C

THERMAL RESISTANCE RATINGS

PARAMETER	SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum Junction-to-Ambient b, d	R _{thJA}	39	48	°C/W
Maximum Junction-to-Foot (Drain)	R _{thJF}	18	22	

Notes

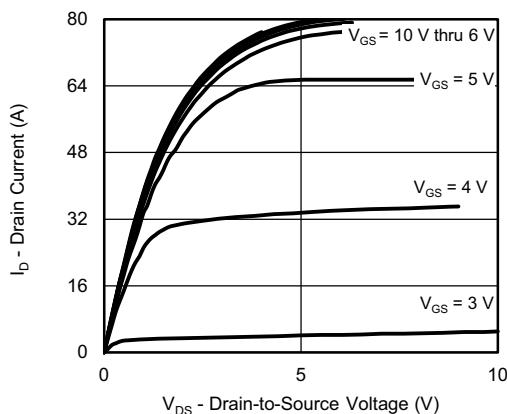
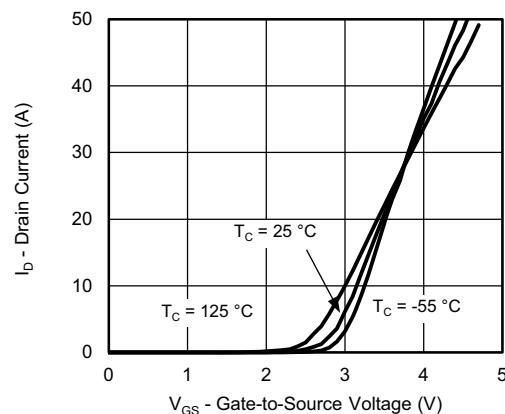
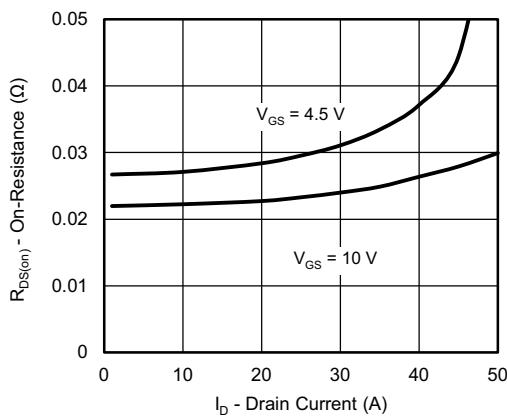
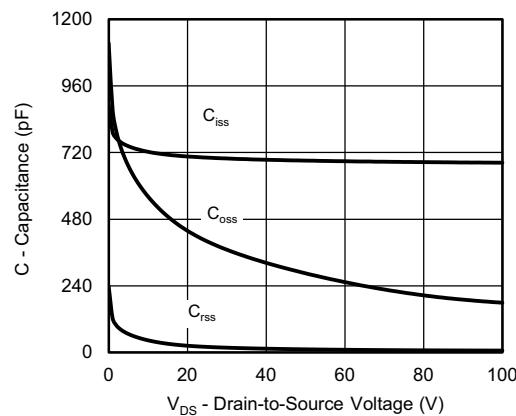
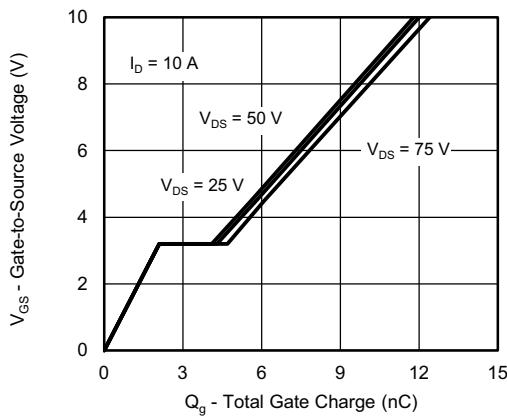
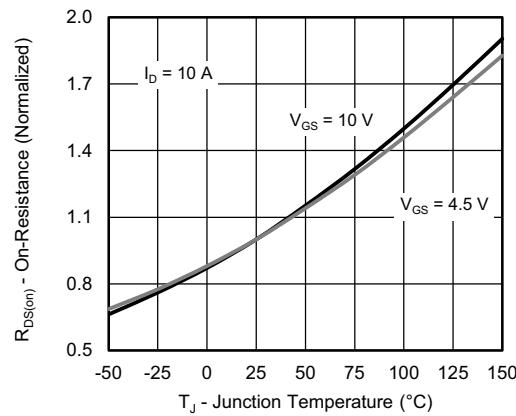
- Based on T_C = 25 °C.
- Surface mounted on 1" x 1" FR4 board
- t = 10 s.
- Maximum under steady state conditions is 90 °C/W.

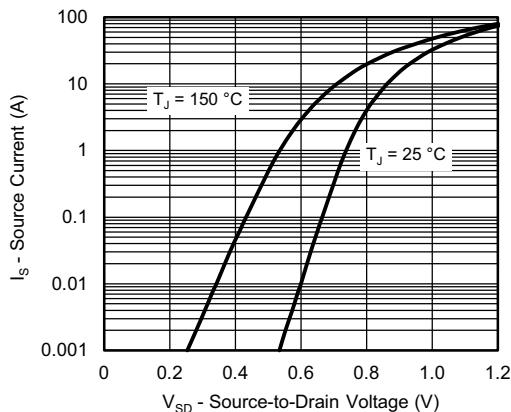
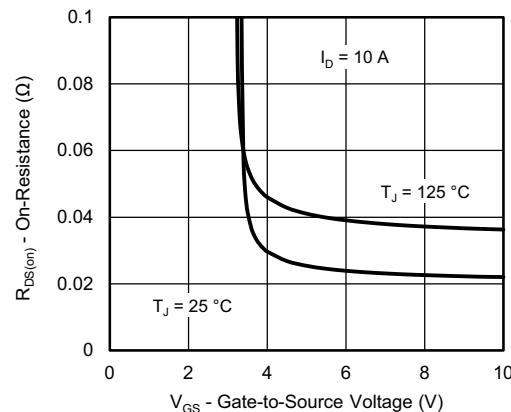
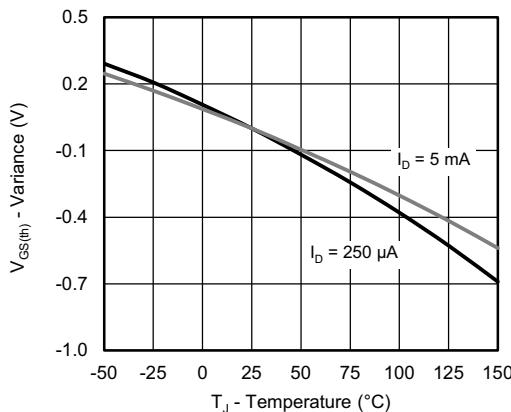
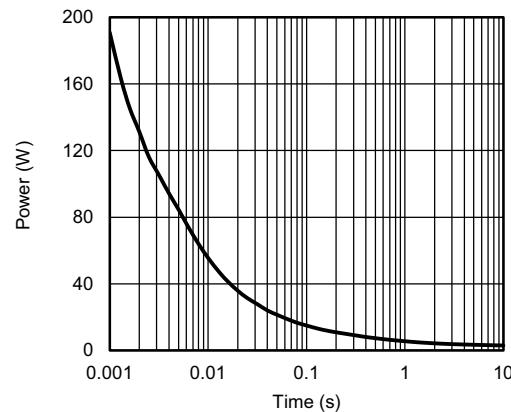
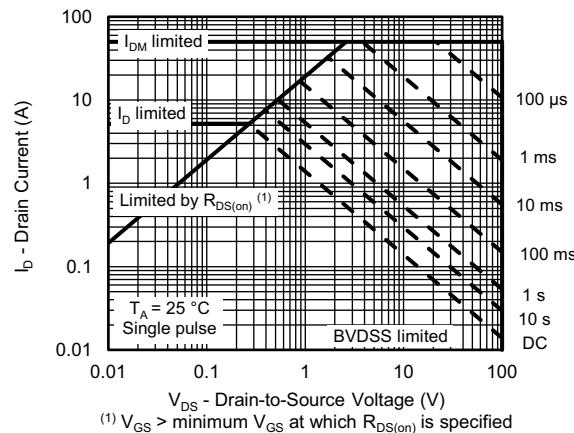
SPECIFICATIONS ($T_J = 25^\circ\text{C}$, unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}$, $I_D = 250 \mu\text{A}$	100	-	-	V
V_{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	$I_D = 250 \mu\text{A}$	-	61	-	mV/°C
$V_{GS(\text{th})}$ Temperature Coefficient	$\Delta V_{GS(\text{th})}/T_J$		-	-3.8	-	
Gate-Source Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}$, $I_D = 250 \mu\text{A}$	1.2	-	2.8	V
Gate-Source Leakage	I_{GSS}	$V_{DS} = 0 \text{ V}$, $V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 100 \text{ V}$, $V_{GS} = 0 \text{ V}$	-	-	1	μA
		$V_{DS} = 100 \text{ V}$, $V_{GS} = 0 \text{ V}$, $T_J = 70^\circ\text{C}$	-	-	10	
On-State Drain Current ^a	$I_{D(\text{on})}$	$V_{DS} \geq 5 \text{ V}$, $V_{GS} = 10 \text{ V}$	20	-	-	A
Drain-Source On-State Resistance ^a	$R_{DS(\text{on})}$	$V_{GS} = 10 \text{ V}$, $I_D = 10 \text{ A}$	-	0.0217	0.0260	Ω
		$V_{GS} = 4.5 \text{ V}$, $I_D = 8 \text{ A}$	-	0.0266	0.0330	
Forward Transconductance ^a	g_{fs}	$V_{DS} = 15 \text{ V}$, $I_D = 10 \text{ A}$	-	31	-	S
Dynamic ^b						
Input Capacitance	C_{iss}	$V_{DS} = 50 \text{ V}$, $V_{GS} = 0 \text{ V}$, $f = 1 \text{ MHz}$	-	690	-	pF
Output Capacitance	C_{oss}		-	280	-	
Reverse Transfer Capacitance	C_{rss}		-	11	-	
Total Gate Charge	Q_g	$V_{DS} = 50 \text{ V}$, $V_{GS} = 10 \text{ V}$, $I_D = 10 \text{ A}$	-	12	18	nC
		$V_{DS} = 50 \text{ V}$, $V_{GS} = 4.5 \text{ V}$, $I_D = 10 \text{ A}$	-	5.8	9	
Gate-Source Charge	Q_{gs}	$V_{DS} = 50 \text{ V}$, $V_{GS} = 4.5 \text{ V}$, $I_D = 10 \text{ A}$	-	2.1	-	nC
Gate-Drain Charge	Q_{gd}		-	2.2	-	
Output Charge	Q_{oss}	$V_{DS} = 50 \text{ V}$, $V_{GS} = 0 \text{ V}$	-	22.5	35	
Gate Resistance	R_g	$f = 1 \text{ MHz}$	0.8	2.2	4.0	Ω
Turn-On Delay Time	$t_{d(\text{on})}$	$V_{DD} = 50 \text{ V}$, $R_L = 5 \Omega$ $I_D \approx 10 \text{ A}$, $V_{GEN} = 4.5 \text{ V}$, $R_g = 1 \Omega$	-	8	16	ns
Rise Time	t_r		-	17	34	
Turn-Off Delay Time	$t_{d(\text{off})}$		-	11	22	
Fall Time	t_f		-	8	16	
Turn-On Delay Time	$t_{d(\text{on})}$		-	7	14	
Rise Time	t_r		-	16	32	
Turn-Off Delay Time	$t_{d(\text{off})}$	$V_{DD} = 50 \text{ V}$, $R_L = 5 \Omega$ $I_D \approx 10 \text{ A}$, $V_{GEN} = 10 \text{ V}$, $R_g = 1 \Omega$	-	12	24	ns
Fall Time	t_f		-	7	14	
Drain-Source Body Diode Characteristics						
Continuous Source-Drain Diode Current	I_S	$T_C = 25^\circ\text{C}$	-	-	5	A
Pulse Diode Forward Current ^a	I_{SM}		-	-	50	
Body Diode Voltage	V_{SD}	$I_S = 5 \text{ A}$	-	0.81	1.1	V
Body Diode Reverse Recovery Time	t_{rr}	$I_F = 10 \text{ A}$, $di/dt = 100 \text{ A}/\mu\text{s}$, $T_J = 25^\circ\text{C}$	-	56	112	ns
Body Diode Reverse Recovery Charge	Q_{rr}		-	60	120	nC
Reverse Recovery Fall Time	t_a		-	48	-	ns
Reverse Recovery Rise Time	t_b		-	8	-	

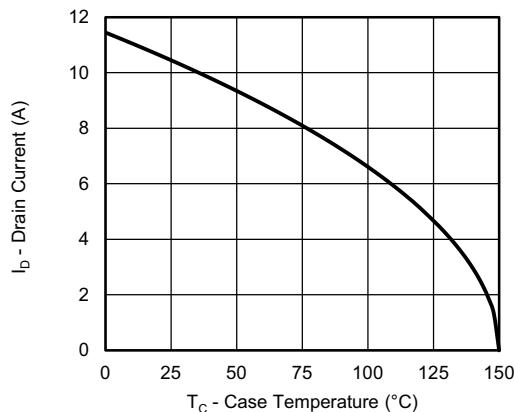
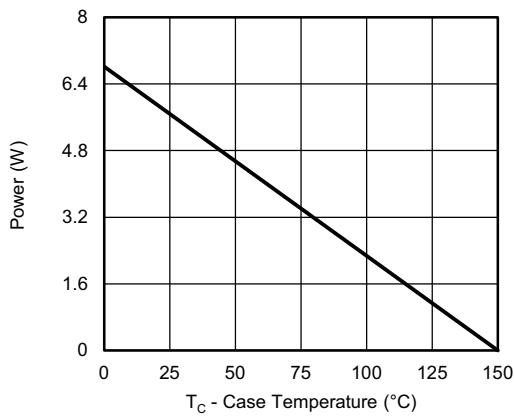
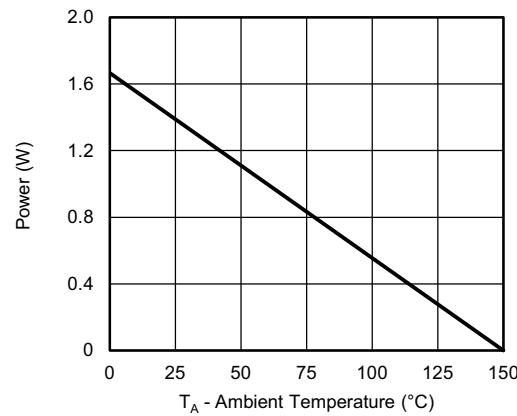
Notes

a. Pulse test; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2 \%$.
b. Guaranteed by design, not subject to production testing.

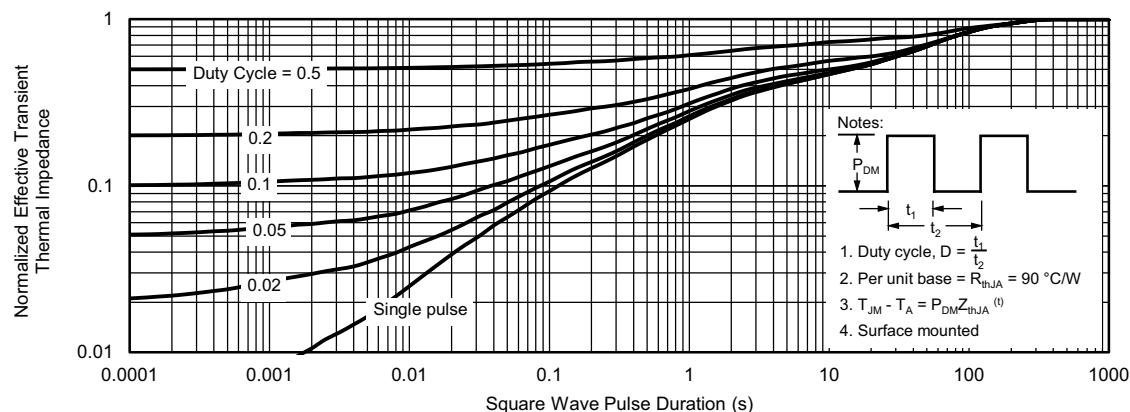
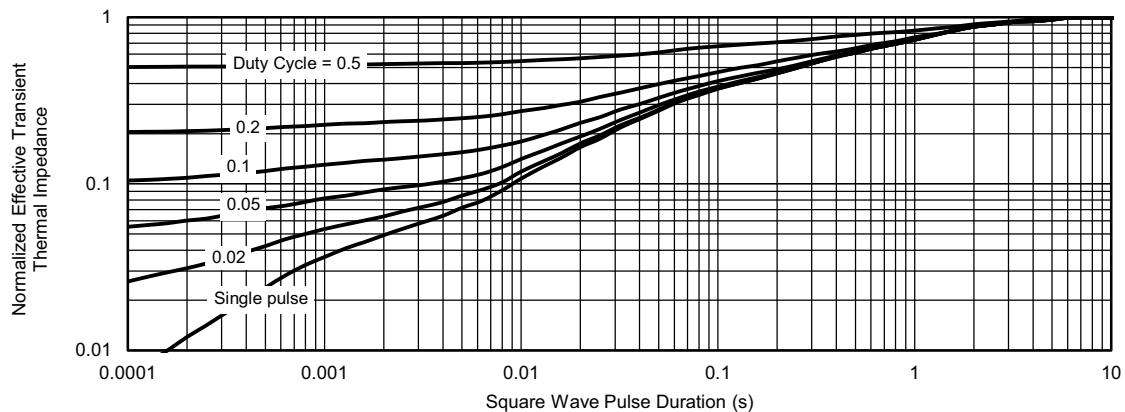
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Output Characteristics

Transfer Characteristics

On-Resistance vs. Drain Current

Capacitance

Gate Charge

On-Resistance vs. Junction Temperature

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Source-Drain Diode Forward Voltage

On-Resistance vs. Gate-to-Source Voltage

Threshold Voltage

Single Pulse Power, Junction-to-Ambient

Safe Operating Area, Junction-to-Ambient

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Current Derating ^a

Power, Junction-to-Foot

Power, Junction-to-Ambient
Note

a. The power dissipation P_D is based on T_J (max.) = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Normalized Thermal Transient Impedance, Junction-to-Ambient

Normalized Thermal Transient Impedance, Junction-to-Foot

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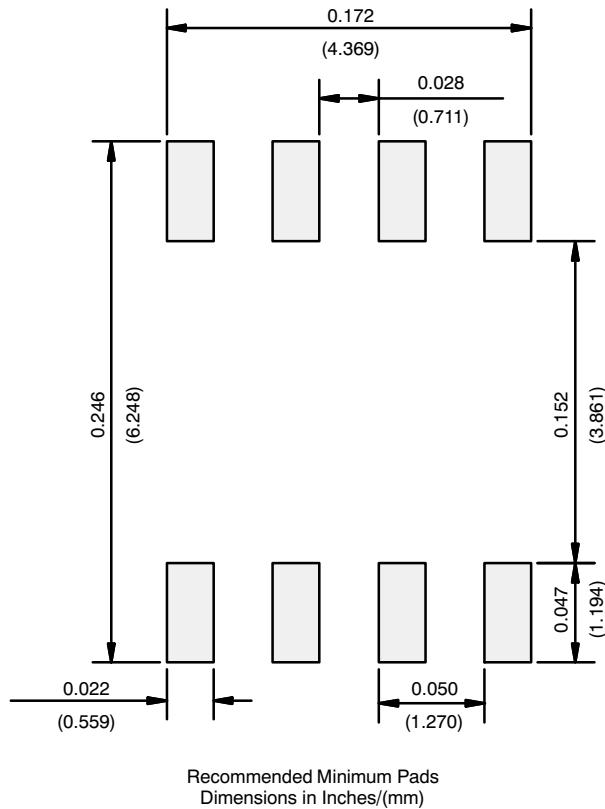
SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012



DIM	MILLIMETERS		INCHES	
	Min	Max	Min	Max
A	1.35	1.75	0.053	0.069
A ₁	0.10	0.20	0.004	0.008
B	0.35	0.51	0.014	0.020
C	0.19	0.25	0.0075	0.010
D	4.80	5.00	0.189	0.196
E	3.80	4.00	0.150	0.157
e	1.27 BSC		0.050 BSC	
H	5.80	6.20	0.228	0.244
h	0.25	0.50	0.010	0.020
L	0.50	0.93	0.020	0.037
q	0°	8°	0°	8°
S	0.44	0.64	0.018	0.026
ECN: C-06527-Rev. I, 11-Sep-06				
DWG: 5498				

RECOMMENDED MINIMUM PADS FOR SO-8



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